



2827



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In re application of: Leendert J. van der Windt
Application No.: 10/060,563
Art Unit: 2827/
Filed: January 30, 2002
For: APPARATUS AND METHOD OF
MANUFACTURING PRINTED
CIRCUIT BOARDS

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service on this date, in an envelope as cited under 37 CFR § 1.8 with sufficient postage as first class mail, addressed to Mail Stop Non-Fee Amendment, the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Cindy K. Moran
Cindy K. Moran

Date: June 12, 2003

RESPONSE TO OFFICE ACTION

In response to the Office Action mailed March 12, 2003, please amend the application as follows:

In the Specification:

Applicant herein amends the title of the invention as follows:

INTEGRATED CIRCUIT HEAT SINK DEVICE AND METHOD

In addition, Applicant has amended portions of the Specification, as set forth in the attached replacement pages, to correct typographical errors and incorrect references. No new matter has been added to the case.

In the Drawings:

Applicant herein amends Figs. 1-5. Replacement drawing pages are attached herewith.

In the Claims:

Applicant previously elected claims 22-42, causing claims 1-21 to be withdrawn. Applicant hereby cancels claims 22-42. Applicant herein adds claims 43-62. No new matter has been added to the case. A marked-up version of the claims, as amended herein, follows.